## Am79514

## Subscriber Line Interface Circuit

## DISTINCTIVE CHARACTERISTICS

■ Programmable constant-current feed

- Programmable loop-detect threshold

■ On-chip switching regulator for low-power dissipation
■ Polarity reversal feature

- Optimized for -60 V battery

Line feed characteristics independent of battery variations

- Two-wire impedance set by single external impedance
- Tip Open state for ground-start lines
- Ring and test relay drivers

■ On-hook transmission

## BLOCK DIAGRAM



## ORDERING INFORMATION

## Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the elements below.


| Valid Combinations |  |  |
| :---: | :---: | :---: |
| Am7951X | -1 | JC |
|  | -2 |  |

## Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

Note:

* Functionality of the device from $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ is guaranteed by production testing. Performance from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ is guaranteed by characterization and periodic sampling of production units.


## CONNECTION DIAGRAMS

Top View


1. Pin 1 is marked for orientation.
2. TP is a thermal conduction pin tied to substrate.

## AMDit

## PIN DESCRIPTIONS

| Pin Names | Type | Description |
| :---: | :---: | :---: |
| AGND | Gnd | Analog ground. |
| A(TIP) | Output | Output of A(TIP) power amplifier. |
| BGND | Gnd | Battery (power) ground. |
| B(RING) | Output | Output of B(RING) power amplifier. |
| C3-C1 | Inputs | Decoder. TTL compatible. C3 is MSB and C1 is LSB. |
| C4 | Input | Test relay driver command. TTL compatible. A logic High enables the driver. |
| DGND | Gnd | Digital ground. |
| CHCLK | Input | Chopper clock. Input to switching regulator (TTL compatible) Frequency $=256 \mathrm{kHz}$ (nominal). |
| CHS | Input | Chopper stabilization. Connection for external stabilization components. |
| DA | Input | Ring-Trip negative. Negative input to ring-trip comparator. |
| DB | Input | Ring-Trip positive. Positive input to ring-trip comparator. |
| DET | Output | Detector. When enabled, a logic Low indicates that the selected detector is tripped. The detector is selected by the logic inputs (C3-C1 and E1). The output is open-collector with a built-in $15 \mathrm{k} \Omega$ pull-up resistor. |
| E0 | Input | Read enable. A logic High enables $\overline{\mathrm{DET}}$. A logic Low disables $\overline{\mathrm{DET}}$. |
| E1 | Input | Ground key enable. E1 = High connects the ground-key detector to $\overline{\mathrm{DET}}$, and E1 = Low connects the off-hook or ring-trip detector to $\overline{\mathrm{DET}}$. |
| HPA | Capacitor | High-pass filter capacitor. A(TIP) side of high-pass filter capacitor. |
| HPB | Capacitor | High-pass filter capacitor. B(RING) side of high-pass filter capacitor. |
| L | Output | Switching regulator power transistor. Connection point for filter inductor and anode of catch diode. This pin will have up to 60 V of pulse waveform on it and must be isolated from sensitive circuits. Extreme care must be taken to keep the diode connections short because of the high currents and high di/dt. |
| QBAT | Battery | Quiet battery. Filtered battery supply for the signal processing circuits. An external $100 \Omega, 1 / 8 \Omega$ resistor must be connected between QBAT and VBAT pins. |
| RD | Resistor | Detect resistor. Threshold modification and filter point for the off-hook detector. |
| RDC | Resistor | DC feed resistor. Connection point for the DC feed current programming network. The other end of the network connects to the receiver summing node (RSN). The sign of $\mathrm{V}_{\mathrm{RDC}}$ is negative for normal polarity and positive for reverse polarity. |
| RINGOUT | Output | Ring relay driver. Sourcing from BGND with internal diode to QBAT. |
| RSN | Input | Receive summing node. The metallic current (both AC and DC) between A(TIP) and B(RING) is equal to 1000 times the current into this pin. The networks that program receive gain, two-wire impedance, and feed current all connect to this node. This node is extremely sensitive. Care should be taken to route the $256-\mathrm{kHz}$ chopper clock and switch lines away from the RSN node. |
| TESTOUT | Output | Test relay driver. Sourcing from BGND with internal diode to QBAT. |
| TP | Thermal | Thermal pin. Connection for heat dissipation. Internally connected to substrate (QBAT). Leave as open circuit or connected to QBAT. In both cases, the TP pins can connect to an area of copper on the board to enhance heat dissipation. |
| VBAT | Battery | Battery Supply. |
| VCC | Power | +5 V power supply. |
| VEE | Power | -5 V power supply. |
| VREG | Input | Regulated voltage. Provides negative power supply for power amplifiers, connection point for inductor, filter capacitor, and chopper stabilization. |
| VTX | Output | Transmit audio. This output is a unity gain version of the $A(T I P)$ and $B($ RING ) metallic voltage. The other end of the two-wire input impedance programming network connects here. |

## ABSOLUTE MAXIMUM RATINGS

Storage temperature $\qquad$ $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
$\mathrm{V}_{\mathrm{CC}}$ with respect to AGND/DGND ..... -0.4 V to +7.0 V
$\mathrm{V}_{\mathrm{EE}}$ with respect to AGND/DGND...... +0.4 V to -7.0 V
$\mathrm{V}_{\text {BAT }}$ with respect to AGND/DGND ..... +0.4 V to -70 V
Note: Rise time of $V_{B A T}(d v / d t)$ must be limited to 27 V /us or less when $Q_{B A T}$ bypass $=0.33 \mu F$.

BGND with respect to AGND/DGND.. +1.0 V to -3.0 V
A (TIP) or $\mathrm{B}($ RING $)$ to BGND:
Continuous ................................... -70 V to +1.0 V
$10 \mathrm{~ms}(\mathrm{f}=0.1 \mathrm{~Hz}$ ) ......................... -70 V to $+5.0 \mathrm{~V}$
$1 \mu \mathrm{~s}(\mathrm{f}=0.1 \mathrm{~Hz}$ ) ............................. -90 V to $+10 \mathrm{~V}$
$250 \mathrm{~ns}(\mathrm{f}=0.1 \mathrm{~Hz}) . . . . . . . . . . . . . . . . . . . . . . . ~-120 \mathrm{~V}$ to +15 V
Current from A(TIP) or B(RING)..................... $\pm 150 \mathrm{~mA}$
Voltage on RINGOUT ....... BGND to 70 V above $\mathrm{Q}_{\text {BAT }}$
Voltage on TESTOUT ....... BGND to 70 V above $\mathrm{Q}_{\text {BAT }}$
Current through relay drivers $\qquad$ 60 mA
Voltage on ring-trip inputs DA and DB ....... $\mathrm{V}_{\mathrm{BAT}}$ to 0 V
Current into ring-trip inputs............................... $\pm 10 \mathrm{~mA}$
Peak current into regulator switch (L pin) ........ 150 mA
Switcher transient peak off voltage on L pin ....... 1.0 V
C4-C1, E1, CHCLK,
to AGND/DGND .................... 0.4 V to $\mathrm{V}_{\mathrm{CC}}+0.4 \mathrm{~V}$
Maximum power dissipation, (see note) ...... $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$
In 32-pin PLCC package. $\qquad$ 1.74 W

Note: Thermal limiting circuitry on chip will shut down the circuit at a junction temperature of about $165^{\circ} \mathrm{C}$. The device should never be exposed to this temperature. Operation above $145^{\circ} \mathrm{C}$ junction temperature may degrade device reliability. See the SLIC Packaging Considerations for more information.
Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability.

## OPERATING RANGES

## Commercial (C) Devices

Ambient temperature ............................ $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ *
$\mathrm{V}_{\mathrm{CC}} . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . ~ 4.75 ~ V ~ t o ~ 5.25 ~ V ~$
$\mathrm{V}_{\mathrm{EE}} . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . ~ 4.75 ~ V ~ t o ~-5.25 ~ V ~$
$V_{\text {BAT }}$................................................... -40 V to -63 V
AGND/DGND 0 V

## BGND with respect to

 AGND/DGND $\qquad$ -100 mV to +100 mV Load resistance on VTX to ground $\qquad$ $10 \mathrm{k} \Omega$ minOperating Ranges define those limits between which the functionality of the device is guaranteed.
${ }^{*}$ Functionality of the device from $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ is guaranteed by production testing. Performance from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ is guaranteed by characterization and periodic sampling of production units.

## ELECTRICAL CHARACTERISTICS

| Description | Test Conditions (See Note 1) | Min | Typ | Max | Unit | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog ( $\mathrm{V}_{\text {TX }}$ ) output impedance |  |  | 3 | 20 | W |  |
| Analog ( $\mathrm{V}_{\mathrm{TX}}$ ) output offset | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & \hline-35 \\ & -40 \end{aligned}$ |  | $\begin{aligned} & +35 \\ & +40 \end{aligned}$ | mV | - |
| Analog (RSN) input impedance | 300 Hz to 3.4 kHz |  | 1 | 20 |  |  |
| Longitudinal impedance at A or B |  |  |  | 35 | W |  |
| Overload level $\mathrm{Z}_{2 \mathrm{WIN}}=600 \Omega \text { to } 900 \Omega$ | 4-wire 2-wire | $\begin{aligned} & -3.1 \\ & -3.1 \end{aligned}$ |  | $\begin{aligned} & +3.1 \\ & +3.1 \end{aligned}$ | Vpk | 2 |
| Transmission Performance, 2-Wire Impedance |  |  |  |  |  |  |
| 2-wire return loss (See Test Circuit D) | 300 Hz to 500 Hz 500 Hz to 2500 Hz 2500 Hz to 3400 Hz | $\begin{aligned} & 26 \\ & 26 \\ & 20 \end{aligned}$ |  |  | dB | - |
| Longitudinal Balance (2-Wire and 4-Wire, See Test Circuit C) |  |  |  |  |  |  |
| Longitudinal to metallic L-T, L-4 | 200 Hz to $1 \mathrm{kHz}:$ $-1^{*}$ <br> normal polarity  <br> $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ -2 <br> normal polarity -2 <br> $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ -2 <br> reverse polarity  | $\begin{aligned} & 50 \\ & 63 \\ & 58 \\ & 58 \end{aligned}$ |  |  |  | 5 |
|  | 1 kHz to $3.4 \mathrm{kHz}:$ $-1^{*}$ <br> normal polarity  <br> $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ -2 <br> normal polarity -2 <br> $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ -2 <br> reverse polarity  | 52 <br> 58 <br> 54 <br> 54 |  |  | dB |  |
| Longitudinal sum (L-T) + (T-L) | 300 to 3400 Hz | 95 |  |  |  |  |
| Longitudinal signal generation 4-L or T-L | $\begin{aligned} & 300 \text { to } 800 \mathrm{~Hz} \\ & 800 \text { to } 3400 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 40 \\ & 35 \end{aligned}$ |  |  |  |  |
| Longitudinal current capability per wire | Active state OHT state |  |  | $\begin{gathered} \hline 17 \\ 8 \end{gathered}$ | mArms |  |
| Insertion Loss (2- to 4-Wire and 4- to 2-Wire, See Test Circuits A and B) |  |  |  |  |  |  |
| Gain accuracy | $\|$$0 \mathrm{dBm}, 1 \mathrm{kHz}$,  <br> $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$  <br> $0 \mathrm{dBm}, 1 \mathrm{kHz}$,  <br> $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$  <br> $0 \mathrm{dBm}, 1 \mathrm{kHz}$, $-1^{*}$ <br> $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ -1 <br> $0 \mathrm{dBm}, 1 \mathrm{kHz}$,  <br> $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$  | $\begin{aligned} & -0.15 \\ & -0.20 \\ & -0.1 \\ & -0.15 \end{aligned}$ |  | $\begin{aligned} & +0.15 \\ & +0.20 \\ & +0.1 \\ & +0.15 \end{aligned}$ | dB | 4 <br> 4 |
| Variation with frequency | $\begin{aligned} & 300 \mathrm{~Hz} \text { to } 3400 \mathrm{~Hz} \\ & \text { Relative to } 1 \mathrm{kHz} \\ & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{gathered} -0.1 \\ -0.15 \end{gathered}$ |  | $\begin{gathered} +0.1 \\ +0.15 \end{gathered}$ |  | 4 |
| Gain tracking | $\begin{aligned} & +7 \mathrm{dBm} \text { to }-55 \mathrm{dBm} \\ & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{gathered} -0.1 \\ -0.15 \end{gathered}$ |  | $\begin{gathered} +0.1 \\ +0.15 \end{gathered}$ |  |  |

## Note:

* P.G. = Performance Grade


## ELECTRICAL CHARACTERISTICS (CONTINUED)

| Description | Test Conditions (See Note 1) | Min | Typ | Max | Unit | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Balance Return Signal (4-Wire to 4-Wire, See Test Circuit B) |  |  |  |  |  |  |
| Gain accuracy | $\left\|\begin{array}{cc}0 \mathrm{dBm}, 1 \mathrm{kHz}, & \\ 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} & \\ 0 \mathrm{dBm}, 1 \mathrm{kHz}, & \\ -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} & \\ 0 \mathrm{dBm}, 1 \mathrm{kHz}, & -1^{*} \\ 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} & -1 \\ 0 \mathrm{dBm}, 1 \mathrm{kHz}, & \\ -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} & \end{array}\right\|$ | $\begin{gathered} -0.15 \\ -0.20 \\ -0.1 \\ -0.15 \end{gathered}$ |  | $\begin{aligned} & +0.15 \\ & +0.20 \\ & +0.1 \\ & +0.15 \end{aligned}$ | dB | 4 <br> 4 |
| Variation with frequency | $\begin{aligned} & 300 \mathrm{~Hz} \text { to } 3400 \mathrm{~Hz} \\ & \text { Relative to } 1 \mathrm{kHz} \\ & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{gathered} -0.1 \\ -0.15 \end{gathered}$ |  | $\begin{gathered} +0.1 \\ +0.15 \end{gathered}$ |  | 4 |
| Gain tracking | $\begin{aligned} & +7 \mathrm{dBm} \text { to }-55 \mathrm{dBm} \\ & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ | $\begin{gathered} -0.1 \\ -0.15 \end{gathered}$ |  | $\begin{gathered} +0.1 \\ +0.15 \end{gathered}$ |  |  |
| Group delay | $\mathrm{f}=1 \mathrm{kHz}$ |  | 5.3 |  | $\mu \mathrm{s}$ |  |
| Total Harmonic Distortion (2- to 4-Wire or 4- to 2-Wire, See Test Circuits A and B) |  |  |  |  |  |  |
| Distortion level | $0 \mathrm{dBm}, 300 \mathrm{~Hz}$ to 3400 Hz |  | -64 | -50 | dB |  |
| Distortion level | +9 dBm |  | -55 | -40 |  |  |
| Idle Channel Noise |  |  |  |  |  |  |
| Psophometric weighted noise | 2-wire $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ <br> 2-wire $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | $\begin{aligned} & \hline-83 \\ & -83 \end{aligned}$ | $\begin{aligned} & -78 \\ & -75 \end{aligned}$ | dBmp | $\begin{gathered} 7 \\ 4,7 \end{gathered}$ |
|  | 4-wire $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ <br> 4-wire $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | $\begin{aligned} & -83 \\ & -83 \end{aligned}$ | $\begin{aligned} & -78 \\ & -75 \end{aligned}$ |  | $\begin{gathered} 7 \\ 4,7 \end{gathered}$ |
| Single Frequency Out-of-Band Noise (See Test Circuit E) |  |  |  |  |  |  |
| Metallic | $\begin{aligned} & \hline 4 \mathrm{kHz} \text { to } 9 \mathrm{kHz} \\ & 9 \mathrm{kHz} \text { to } 1 \mathrm{MHz} \\ & 256 \mathrm{kHz} \text { and harmonics } \end{aligned}$ |  | $\begin{aligned} & -76 \\ & -76 \\ & -57 \end{aligned}$ |  | dBm | $\begin{gathered} 4,5,9 \\ 4,5 \end{gathered}$ |
| Longitudinal | 1 kHz to 15 kHz Above 15 kHz 256 kHz and harmonics |  | $\begin{array}{r} \hline-70 \\ -85 \\ -57 \\ \hline \end{array}$ |  |  | $\begin{gathered} 4,5,9 \\ 4,5 \end{gathered}$ |
| DC Feed Current and Voltage (See Figure 1) <br> Unless otherwise noted, Battery $=60 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{BAT}}=-59.3 \mathrm{~V}\right)$ |  |  |  |  |  |  |
| Active state loop-current accuracy | $\begin{array}{ll} \mid \mathrm{l}_{\text {LOOP }}(\text { nominal })=40 \mathrm{~mA} \\ \mathrm{R}_{\mathrm{L}}=2000 \Omega, \text { Battery }=62 \mathrm{~V} & -1^{*} \\ \mathrm{R}_{\mathrm{L}}=2080 \Omega & -2 \end{array}$ | $\begin{gathered} -7.5 \\ 23 \\ 22.7 \end{gathered}$ |  | +7.5 | $\begin{gathered} \% \\ \mathrm{~mA} \\ \mathrm{~mA} \end{gathered}$ | 4 |
| On-hook loop voltage | $\mathrm{R}_{\mathrm{L}}=\infty$ | 47.5 | 49 |  | V |  |
| OHT state Tip Open state Disconnect state | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega \\ & \mathrm{R}_{\mathrm{L}}=0 \end{aligned}$ | 18 | 20 | $\begin{aligned} & 22 \\ & 1.0 \\ & 1.0 \end{aligned}$ | mA |  |
| Power Dissipation, Battery = -60 V |  |  |  |  |  |  |
| On-hook Open Circuit state On-hook OHT state On-hook Active state Off-hook OHT state Off-hook Active state | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega \\ & \mathrm{R}_{\mathrm{L}}=600 \Omega \end{aligned}$ |  | $\begin{gathered} \hline 50 \\ 175 \\ 260 \\ 500 \\ 650 \\ \hline \end{gathered}$ | $\begin{gathered} 120 \\ 250 \\ 400 \\ 750 \\ 1000 \\ \hline \end{gathered}$ | mW |  |

ELECTRICAL CHARACTERISTICS (CONTINUED)

| Description | Test Conditions (See Note 1) | Min | Typ | Max | Unit | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Currents |  |  |  |  |  |  |
| $\mathrm{V}_{\text {CC }}$ On-hook supply current | Open Circuit state OHT state Active state |  | $\begin{gathered} 3 \\ 6 \\ 7.5 \end{gathered}$ | $\begin{aligned} & 4.5 \\ & 10 \\ & 12 \end{aligned}$ |  |  |
| VEE On-hook supply current | Open Circuit state OHT state Active state |  | $\begin{aligned} & 1.0 \\ & 2.2 \\ & 2.7 \end{aligned}$ | $\begin{aligned} & \hline 2.3 \\ & 3.5 \\ & 6.0 \\ & \hline \end{aligned}$ | mA |  |
| $\mathrm{V}_{\text {BAT }}$ On-hook supply current | Open Circuit state OHT state Active state |  | $\begin{aligned} & 0.4 \\ & 3.0 \\ & 4.0 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 5.0 \\ & 6.0 \end{aligned}$ |  |  |
|  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {CC }}$ | 40 Hz to 3400 Hz 3.4 kHz to 50 kHz | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ | $\begin{aligned} & 35 \\ & 30 \end{aligned}$ |  |  | 6,7 |
| $\mathrm{V}_{\mathrm{EE}}$ | $\begin{aligned} & 40 \mathrm{~Hz} \text { to } 3400 \mathrm{~Hz} \\ & 3.4 \mathrm{kHz} \text { to } 50 \mathrm{kHz} \end{aligned}$ | $\begin{aligned} & 20 \\ & 15 \end{aligned}$ | $\begin{aligned} & 30 \\ & 25 \end{aligned}$ |  | dB | 6,7 - |
| $\mathrm{V}_{\text {BAT }}$ | 40 Hz to 3400 Hz 3.4 kHz to 50 kHz | $\begin{aligned} & 27 \\ & 20 \end{aligned}$ | $\begin{aligned} & 30 \\ & 30 \end{aligned}$ |  |  | 6,7 |
| Off-Hook Detector |  |  |  |  |  |  |
| Current threshold | $\mathrm{I}_{\mathrm{DET}}=365 / \mathrm{R}_{\mathrm{D}}$ | -20 |  | +20 | \% |  |
| Ground-Key Detector Thresholds Active State, Battery = -60 V |  |  |  |  |  |  |
| Ground-key resistance threshold | B(RING) to GND | 2.0 | 4.2 | 10.0 | $\mathrm{k} \Omega$ |  |
| Ground-key current threshold | B(RING) or midpoint to GND |  | 9 |  | mA | 8 |
| Ring-Trip Detector Input |  |  |  |  |  |  |
| Bias current |  | -5 | -0.05 |  | $\mu \mathrm{A}$ |  |
| Offset voltage | Source resistance $=0$ to $200 \mathrm{k} \Omega$ | -50 | 0 | +50 | mV |  |
| Logic Inputs (C4-C1, E1, and CHCLK) |  |  |  |  |  |  |
| Input High voltage |  | 2.0 |  |  | V |  |
| Input Low voltage |  |  |  | 0.8 |  |  |
| Input High current | All inputs except E1 Input E1 | $\begin{aligned} & -75 \\ & -75 \end{aligned}$ |  | $\begin{aligned} & 40 \\ & 45 \end{aligned}$ | $\mu \mathrm{A}$ |  |
| Input Low current |  | -0.4 |  |  | mA |  |
| Logic Output (DET) |  |  |  |  |  |  |
| Output Low voltage | $\mathrm{I}_{\text {OUT }}=0.8 \mathrm{~mA}$ |  |  | 0.4 |  |  |
| Output High voltage | $\mathrm{I}_{\text {OUT }}=-0.1 \mathrm{~mA}$ | 2.4 |  |  |  |  |
| Relay Driver Outputs (RINGOUT, TESTOUT) |  |  |  |  |  |  |
| On voltage | 50 mA source | $\mathrm{B}_{\mathrm{GND}}{ }^{-2}$ |  |  | V |  |
| Off leakage |  |  | 0.5 | 100 | $\mu \mathrm{A}$ |  |
| Clamp voltage | 50 mA sink | $Q_{\text {BAT }}{ }^{-2}$ |  |  | V |  |

## RELAY DRIVER SCHEMATICS



## SWITCHING CHARACTERISTICS

| Symbol | Parameter | Test Conditions | Temperature Ranges | Min | Typ | Max | Unit | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| tgkde | E1 Low to $\overline{\mathrm{DET}} \operatorname{High}(\mathrm{E} 0=1)$ | Ground-key Detect state $\mathrm{R}_{\mathrm{L}}$ open, $\mathrm{R}_{\mathrm{G}}$ connected (See Figure H) | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 3.8 \\ & 4.0 \end{aligned}$ | $\mu \mathrm{s}$ | 4 |
|  | E1 Low to $\overline{\mathrm{DET}}$ Low (E0 = 1) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 1.1 \\ & 1.6 \end{aligned}$ |  |  |
| tgkdd | E0 High to $\overline{\mathrm{DET}}$ Low (E1 = 0) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 1.1 \\ & 1.6 \end{aligned}$ |  |  |
| tgkd0 | E0 Low to $\overline{\text { DET }}$ High (E1 = 0) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 3.8 \\ & 4.0 \end{aligned}$ |  |  |
| tshde | E1 High to $\overline{\mathrm{DET}}$ Low $(\mathrm{E} 0=1)$ | Switchhook Detect state $R_{L}=600 \Omega, R_{G}$ open (See Figure G) | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 1.2 \\ & 1.7 \end{aligned}$ |  |  |
|  | E1 High to $\overline{\text { DET }}$ High (E0 = 1) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 3.8 \\ & 4.0 \end{aligned}$ |  |  |
| tshdd | E0 High to $\overline{\mathrm{DET}}$ Low (E1 = 1) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & \hline 1.1 \\ & 1.6 \end{aligned}$ |  |  |
| tshd0 | E0 Low to $\overline{\mathrm{DET}}$ High (E1 = 1) |  | $\begin{aligned} & 0^{\circ} \mathrm{C} \text { to }+70^{\circ} \mathrm{C} \\ & -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\begin{aligned} & 3.8 \\ & 4.0 \end{aligned}$ |  |  |

## SWITCHING WAVEFORMS



E0 to $\overline{\mathrm{DET}}$


## Note:

All delays measured at 1.4 V level.

## Notes:

1. Unless otherwise noted, test conditions are BAT $=-60 \mathrm{~V}, V_{C C}=+5 \mathrm{~V}, V_{E E}=-5 \mathrm{~V}, R_{L}=600 \Omega, C_{H P}=0.33 \mu F$, $R_{D C 1}=R_{D C 2}=31.25 \mathrm{k} \Omega, C_{D C}=0.1 \mu F, R d=51.1 \mathrm{k} \Omega$, no fuse resistors, two-wire AC output impedance programming impedance $\left(Z_{T}\right)=600 \mathrm{k} \Omega$ resistive, receive input summing impedance $\left(Z_{R X}\right)=300 \mathrm{k} \Omega$ resistive. (See Table 2 for component formulas.)
2. Overload level is defined when $T H D=1 \%$.
3. Balance return signal is the signal generated at $V_{T X}$ by $V_{R X}$. This specification assumes that the two-wire $A C$ load impedance matches the impedance programmed by $Z_{T}$.
4. Not tested in production. This parameter is guaranteed by characterization or correlation to other tests.
5. These tests are performed with a longitudinal impedance of $90 \Omega$ and metallic impedance of $300 \Omega$ for frequencies below 12 kHz and $135 \Omega$ for frequencies greater than 12 kHz . These tests are extremely sensitive to circuit board layout. Please refer to application notes for details.
6. This parameter is tested at 1 kHz in production. Performance at other frequencies is guaranteed by characterization.
7. When the SLIC is in the Anti-Sat 2 operating region, this parameter is degraded. The exact degradation depends on system design. The Anti-Sat 2 region occurs at high loop resistances when $\left|V_{B A T}\right|-\left|V_{A X}-V_{B X}\right|$ is less than approximately $15 V$.
8. "Midpoint" is defined as the connection point between two $300 \Omega$ series resistors connected between $A(T I P)$ and $B(R I N G)$.
9. Fundamental and harmonics from 256 kHz switch regulator chopper are not included.

Table 1. SLIC Decoding

|  |  |  |  |  |  | DET Output |  |
| :---: | :---: | :---: | :---: | :--- | :--- | :--- | :---: |
| State | C3 | C2 | C1 | Two-Wire Status | E1 $=\mathbf{0}$ | E1 $=\mathbf{1}$ |  |
| 0 | 0 | 0 | 0 | Open Circuit | Ring trip | Ring trip |  |
| 1 | 0 | 0 | 1 | Ringing | Ring trip | Ring trip |  |
| 2 | 0 | 1 | 0 | Active | Loop detector | Ground key |  |
| 3 | 0 | 1 | 1 | On-hook TX (OHT) | Loop detector | Ground key |  |
| 4 | 1 | 0 | 0 | Tip Open | Loop detector | - |  |
| 5 | 1 | 0 | 1 | Reserved | Loop detector | - |  |
| 6 | 1 | 1 | 0 | Active Polarity Reversal | Loop detector | Ground key |  |
| 7 | 1 | 1 | 1 | OHT Polarity Reversal | Loop detector | Ground key |  |

Table 2. User-Programmable Components

| $\mathrm{Z}_{\mathrm{T}}=1000\left(\mathrm{Z}_{2 \text { WIN }}-2 \mathrm{R}_{\mathrm{F}}\right)$ | Where $Z_{T}$ is connected between the VTX and RSN pins. The fuse resistors are $R_{F}$, and $Z_{2 \text { wis }}$ is the desired 2 -wire $A C$ input impedance. When computing $Z_{T}$, the internal current amplifier pole and any external stray capacitance between VTX and RSN must be taken into account. |
| :---: | :---: |
| $\mathrm{Z}_{\mathrm{RX}}=\frac{\mathrm{Z}_{\mathrm{L}}}{\mathrm{G}_{42 \mathrm{~L}}} \cdot \frac{1000 \bullet \mathrm{Z}_{\mathrm{T}}}{\mathrm{Z}_{\mathrm{T}}+1000\left(\mathrm{Z}_{\mathrm{L}}+2 \mathrm{R}_{\mathrm{F}}\right)}$ | Where $Z_{R X}$ is connected from $V_{R X}$ to the $R S N$ pin, $Z_{T}$ is defined above, $G_{42 L}$ is the desired receive gain, and $Z_{L}$ is the 2 -wire load impedance. |
| $\mathrm{R}_{\mathrm{DC} 1}+\mathrm{R}_{\mathrm{DC} 2}=\frac{2500}{\mathrm{I}_{\mathrm{FEED}}}$ | Where $R_{D C 1}, R_{D C 2}$, and $C_{D C}$ form the network $C_{D C}=(1.5 \mathrm{~ms})\left(R_{D C 1}+R_{D C 2}\right) /\left(R_{D C 1} \cdot R_{D C 2}\right)$ connected to the $R D C$ pin. $R_{D C 1}$ and $R_{D C 2}$ are approximately equal. |
| $\mathrm{R}_{\mathrm{D}}=\frac{365}{\mathrm{I}_{\mathrm{T}}}, \quad \mathrm{C}_{\mathrm{D}}=\frac{0.5 \mathrm{~ms}}{\mathrm{R}_{\mathrm{D}}}$ | Where $R_{D}$ and $C_{D}$ form the network connected from $R D$ to -5 V and $\mathrm{I}_{\mathrm{T}}$ is the threshold current between on hook and off hook. |

## DC FEED CHARACTERISTICS



Notes:

1. Constant-current region:

Active state, $\mathrm{I}_{\mathrm{L}}=\frac{2500}{\mathrm{R}_{\mathrm{DC}}}$
OHT state, $\mathrm{I}_{\mathrm{L}}=\frac{1}{2} \bullet \frac{2500}{\mathrm{R}_{\mathrm{DC}}}$
2. Anti-sat cut-in:

$$
\begin{array}{ll}
\mathrm{V}_{\mathrm{AB}}=46 \mathrm{~V}, & \left|\mathrm{~V}_{\mathrm{BAT}}\right| \geq 58.9 \mathrm{~V} \\
\mathrm{~V}_{\mathrm{AB}}=1.087\left|\mathrm{~V}_{\mathrm{BAT}}\right|-18.017, & \left|\mathrm{~V}_{\mathrm{BAT}}\right|<58.9 \mathrm{~V}
\end{array}
$$

3. Open Circuit voltage:

$$
\begin{array}{ll}
\mathrm{V}_{\mathrm{AB}}=51.23 \mathrm{~V}, & \left|\mathrm{~V}_{\mathrm{BAT}}\right| \geq 61.5 \mathrm{~V} \\
\mathrm{~V}_{\mathrm{AB}}=1.073\left|\mathrm{~V}_{\mathrm{BAT}}\right|-14.72, & \left|\mathrm{~V}_{\mathrm{BAT}}\right|<61.5 \mathrm{~V}
\end{array}
$$

4. Anti-sat 1 region: $\quad \mathrm{V}_{\mathrm{AB}}=51.23-\mathrm{I}_{\mathrm{L}} \frac{\mathrm{R}_{\mathrm{DC}}}{488.3}$
5. Anti-sat 2 region:

$$
\mathrm{V}_{\mathrm{AB}}=1.073\left|\mathrm{~V}_{\mathrm{BAT}}\right|-14.72-\mathrm{I}_{\mathrm{L}} \frac{\mathrm{R}_{\mathrm{DC}}}{1071}
$$

a. $\mathrm{V}_{\mathrm{A}}-\mathrm{V}_{\mathrm{B}}\left(\mathrm{V}_{\mathrm{AB}}\right)$ Voltage vs. Loop Current (Typical)

## DC FEED CHARACTERISTICS (continued)


b. Loop Current vs. Load Resistance (Typical)


Feed current programmed by $\mathrm{R}_{\mathrm{DC} 1}$ and $\mathrm{R}_{\mathrm{DC} 2}$
c. Feed Programming

Figure 1. DC Feed Characteristics

## TEST CIRCUITS


A. Two- to Four-Wire Insertion Loss
B. Four- to Two-Wire Insertion Loss and Balance Return Signal


## TEST CIRCUITS (continued)


E. Single-Frequency Noise

G. Loop-Detector Switching

F. Ground-Key Detection

H. Ground-Key Switching

## PHYSICAL DIMENSION

## PL032



## REVISION SUMMARY

## Revision A to Revision B

- Minor changes were made to the data sheet style and format to conform to AMD standards.


## Revision B to Revision C

- In Pin Description table, inserted/changed TP pin description to: "Thermal pin. Connection for heat dissipation. Internally connected to substrate (QBAT). Leave as open circuit or connected to QBAT. In both cases, the TP pins can connect to an area of copper on the board to enhance heat dissipation."
- Minor changes were made to the data sheet style and format to conform to AMD standards.


## Revision C to Revision D

- The physical dimension (PL032) was added to the Physical Dimension section.
- Deleted the Ceramic DIP and Plastic DIP part (Am79512) and references to them.
- Updated Pin Description table to correct inconsistencies.

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